

Infineon Technologies in Dresden Facts & Figures

	200 mm factory	300 mm factory
Ground breaking:	July 1994	May 2000
Volume production:	August 1996	December 2001
Employees:	3,500	800
Investments:	1.5 billion Euro	1.1 billion Euro
Investors:	---	M+W Zander, 51 million Euro Messegesellschaft Leipzig, 118 million Euro
Cleanroom area:	2 modules à 5,400 m ²	1 module with 8,840 m ²
Cleanroom class:	1	1,000 (FOUP* concept)
DRAM technology:	0.2– 0.14 micron	0.14 micron and below
Logic IC:	0.17 micron and below	
Products:	64 Mbit, 128 Mbit, 256 Mbit DRAM IC's for mobile and wireline communications, and for chip cards	256 Mbit, 512 Mbit, 1 Gbit DRAM

*FOUP = Front Opening Unified Pod